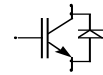


# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

## FZ 800 R 12 KL4C

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**vorläufige Daten**  
**preliminary data**

### Höchstzulässige Werte / Maximum rated values

#### Elektrische Eigenschaften / Electrical properties

Kollektor-Emitter-Sperrspannung collector-emitter voltage		$V_{CES}$	1200	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80\text{ °C}$	$I_{C,nom.}$	800	A
	$T_C = 25\text{ °C}$	$I_C$	1300	A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1\text{ ms}, T_C = 80\text{ °C}$	$I_{CRM}$	1600	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25\text{ °C}, \text{ Transistor}$	$P_{tot}$	5,6	kW
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		$V_{GES}$	+/- 20V	V
Dauergleichstrom DC forward current		$I_F$	800	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1\text{ ms}$	$I_{FRM}$	1600	A
Grenzlastintegral der Diode $I^2t$ - value, Diode	$V_R = 0V, t_p = 10\text{ms}, T_{vj} = 125\text{ °C}$	$I^2t$	240	kA <sup>2</sup> s
Isolations-Prüfspannung insulation test voltage	RMS, $f = 50\text{ Hz}, t = 1\text{ min.}$	$V_{ISOL}$	2,5	kV

### Charakteristische Werte / Characteristic values

#### Transistor / Transistor

			min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	$I_C = 800A, V_{GE} = 15V, T_{vj} = 25\text{ °C}$	$V_{CE\text{ sat}}$	-	2,1	2,6	V
	$I_C = 800A, V_{GE} = 15V, T_{vj} = 125\text{ °C}$		-	2,4		V
Gate-Schwellenspannung gate threshold voltage	$I_C = 32\text{mA}, V_{CE} = V_{GE}, T_{vj} = 25\text{ °C}$	$V_{GE(th)}$	4,5	5,5	6,5	V
Eingangskapazität input capacitance	$f = 1\text{MHz}, T_{vj} = 25\text{ °C}, V_{CE} = 25V, V_{GE} = 0V$	$C_{ies}$	-	56	-	nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	$V_{CE} = 1200V, V_{GE} = 0V, T_{vj} = 25\text{ °C}$	$I_{CES}$	-	0,02	1	mA
	$V_{CE} = 1200V, V_{GE} = 0V, T_{vj} = 125\text{ °C}$		-	1		mA
Gate-Emitter Reststrom gate-emitter leakage current	$V_{CE} = 0V, V_{GE} = 20V, T_{vj} = 25\text{ °C}$	$I_{GES}$	-	-	600	nA

prepared by: Mark Münzer

date of publication: 14.8.1998

approved by: Hubert Ludwig

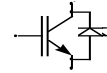
revision: 1c

# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

## FZ 800 R 12 KL4C

eupec



**vorläufige Daten**  
**preliminary data**

### Charakteristische Werte / Characteristic values

Transistor / Transistor			min.	typ.	max.	
Einschaltverzögerungszeit (ind. Last) turn on delay time (inductive load)	$I_C = 800A, V_{CE} = 600V$	$t_{d,on}$	-	0,27	-	$\mu s$
	$V_{GE} = \pm 15V, R_G = 1,8\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 1,8\Omega, T_{vj} = 125^\circ C$					
Anstiegszeit (induktive Last) rise time (inductive load)	$I_C = 800A, V_{CE} = 600V$	$t_r$	-	0,15	-	$\mu s$
	$V_{GE} = \pm 15V, R_G = 1,8\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 1,8\Omega, T_{vj} = 125^\circ C$					
Abschaltverzögerungszeit (ind. Last) turn off delay time (inductive load)	$I_C = 800A, V_{CE} = 600V$	$t_{d,off}$	-	0,9	-	$\mu s$
	$V_{GE} = \pm 15V, R_G = 1,8\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 1,8\Omega, T_{vj} = 125^\circ C$					
Fallzeit (induktive Last) fall time (inductive load)	$I_C = 800A, V_{CE} = 600V$	$t_f$	-	0,09	-	$\mu s$
	$V_{GE} = \pm 15V, R_G = 1,8\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 1,8\Omega, T_{vj} = 125^\circ C$					
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	$I_C = 800A, V_{CE} = 600V, V_{GE} = 15V$ $R_G = 1,8\Omega, T_{vj} = 125^\circ C, L_S = 70nH$	$E_{on}$	-	121	-	mWs
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	$I_C = 800A, V_{CE} = 600V, V_{GE} = 15V$ $R_G = 1,8\Omega, T_{vj} = 125^\circ C, L_S = 70nH$	$E_{off}$	-	127	-	mWs
Kurzschlußverhalten SC Data	$t_p \leq 10\mu sec, V_{GE} \leq 15V, R_G = 1,8\Omega$ $T_{vj} \leq 125^\circ C, V_{CC} = 900V, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$	$I_{SC}$	-	6000	-	A
Modulinduktivität stray inductance module		$L_{sCE}$	-	15	-	nH
Modul Leitungswiderstand, Anschlüsse – Chip module lead resistance, terminals – chip	$T_C = 25^\circ C$	$R_{CC+EE}$	-	0,10	-	m $\Omega$

### Charakteristische Werte / Characteristic values

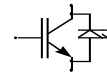
Diode / Diode			min.	typ.	max.	
Durchlaßspannung forward voltage	$I_F = 800A, V_{GE} = 0V, T_{vj} = 25^\circ C$	$V_F$	-	1,8	2,3	V
	$I_F = 800A, V_{GE} = 0V, T_{vj} = 125^\circ C$					
Rückstromspitze peak reverse recovery current	$I_F = 800A, -di_F/dt = 5700A/\mu sec$	$I_{RM}$	-	552	-	A
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$					
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$					
Sperrverzögerungsladung recovered charge	$I_F = 800A, -di_F/dt = 5700A/\mu sec$	$Q_r$	-	74	-	$\mu As$
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$					
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$					
Abschaltenergie pro Puls reverse recovery energy	$I_F = 800A, -di_F/dt = 5700A/\mu sec$	$E_{rec}$	-	24	-	mWs
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$					
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$					

# Technische Information / Technical Information

IGBT-Module  
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**vorläufige Daten**  
**preliminary data**

### Thermische Eigenschaften / Thermal properties

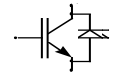
			min.	typ.	max.	
Innerer Wärmewiderstand thermal resistance, junction to case	Transistor / transistor, DC	$R_{thJC}$	-	-	0,022	K/W
	Diode/Diode, DC		-	-	0,04	K/W
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro Modul / per module $d_{paste} \leq 100\mu m / d_{grease} \leq 100\mu m$	$R_{thCK}$	-	-	0,01	K/W
Höchstzulässige Sperrschichttemperatur maximum junction temperature		$T_{vj}$	-	-	150	°C
Betriebstemperatur operation temperature		$T_{op}$	-40	-	125	°C
Lagertemperatur storage temperature		$T_{stg}$	-40	-	125	°C

### Mechanische Eigenschaften / Mechanical properties

Gehäuse, siehe Anlage case, see appendix						
Innere Isolation internal insulation				AL <sub>2</sub> O <sub>3</sub>		
Kriechstrecke creepage distance				17		mm
Luftstrecke clearance				10		mm
CTI comperative tracking index				275		
Anzugsdrehmoment f. mech. Befestigung mounting torque		M1	4,25	5	5,75	Nm
Anzugsdrehmoment f. elektr. Anschlüsse terminal connection torque	terminals M4	M2	1,7	2	2,3	Nm
	terminals M8		8		10	Nm
Gewicht weight		G		1500		g

Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert.  
Sie gilt in Verbindung mit den zugehörigen Technischen Erläuterungen.

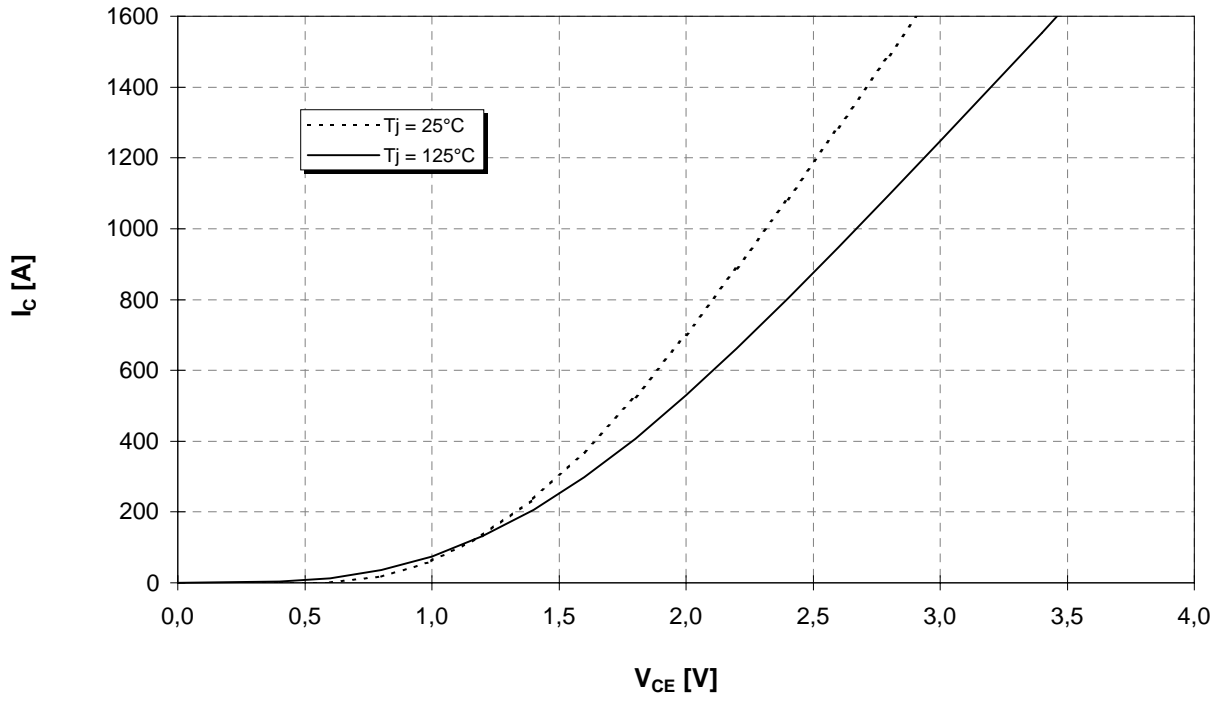
This technical information specifies semiconductor devices but promises no characteristics. It is  
valid in combination with the belonging technical notes.



**Ausgangskennlinie (typisch)**  
**Output characteristic (typical)**

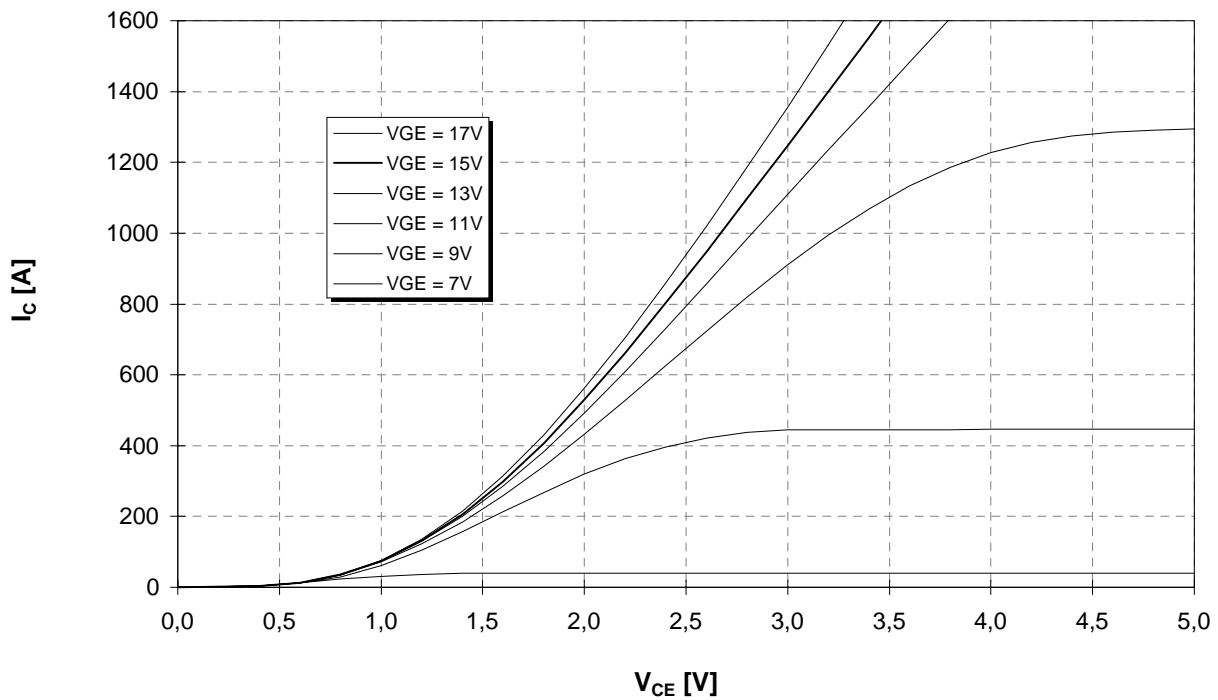
$I_C = f(V_{CE})$   
 $V_{GE} = 15V$

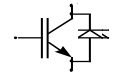
**vorläufige Daten**  
**preliminary data**



**Ausgangskennlinienfeld (typisch)**  
**Output characteristic (typical)**

$I_C = f(V_{CE})$   
 $T_{vj} = 125°C$

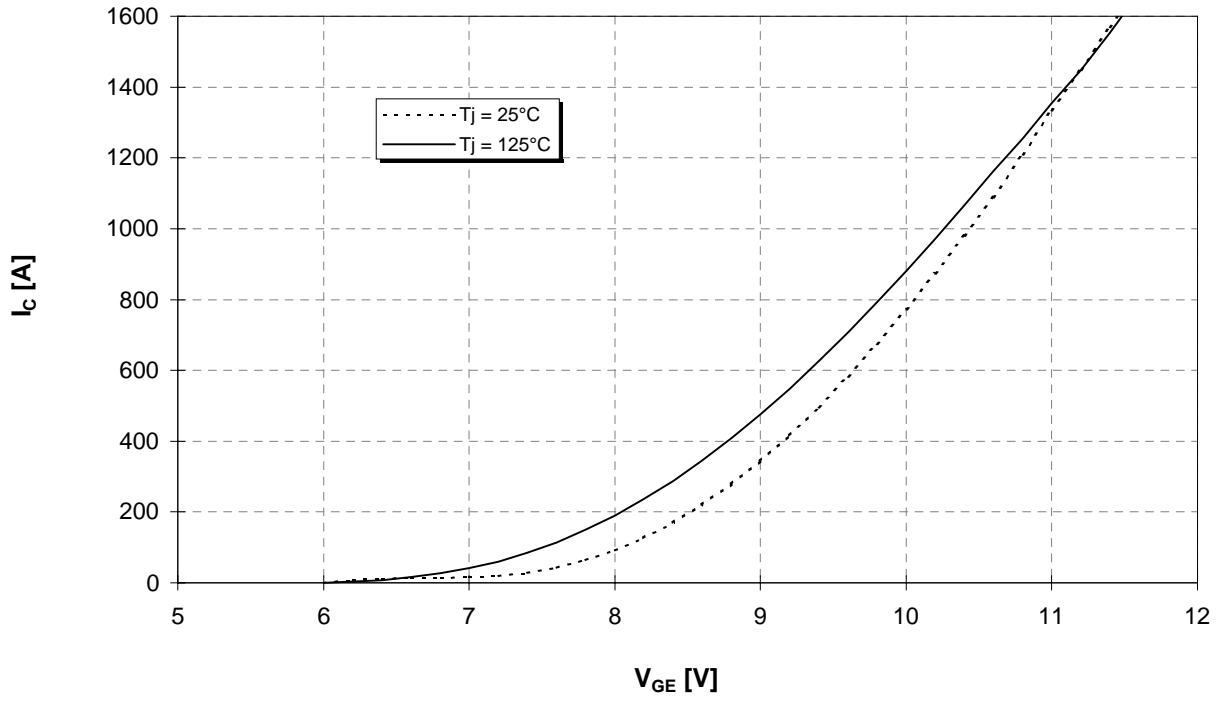




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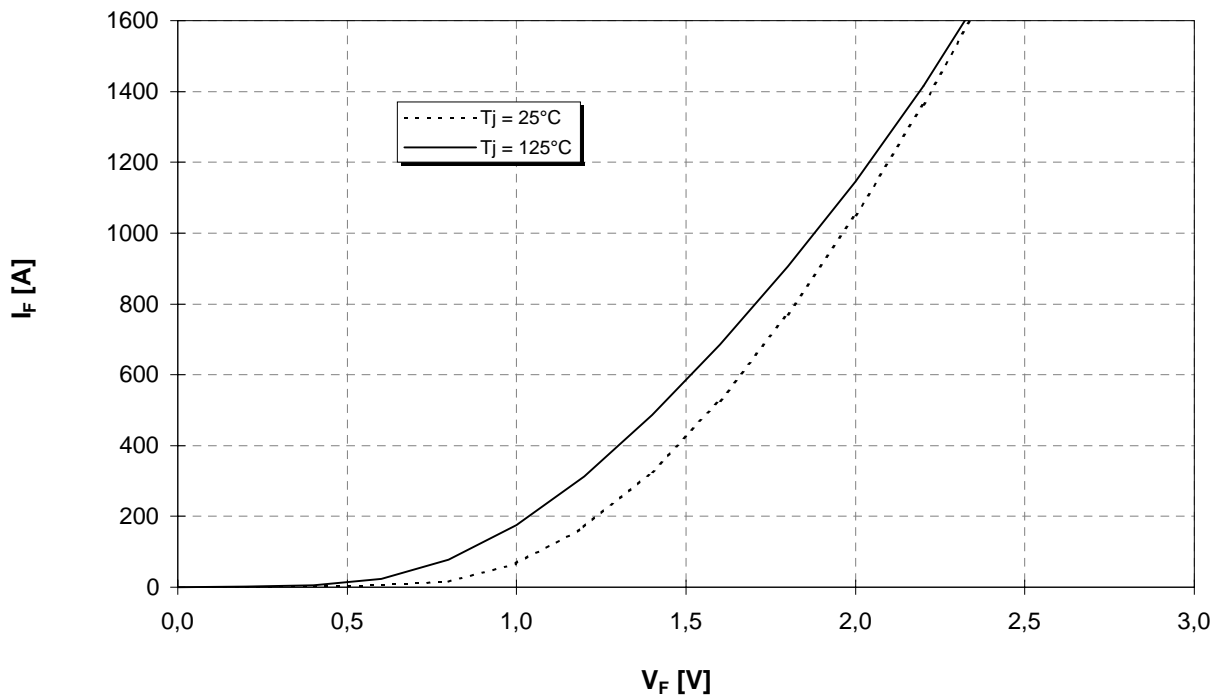
Übertragungscharakteristik (typisch)  
Transfer characteristic (typical)

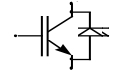
$I_C = f(V_{GE})$   
 $V_{CE} = 20V$



Durchlaßkennlinie der Inversdiode (typisch)  
Forward characteristic of inverse diode (typical)

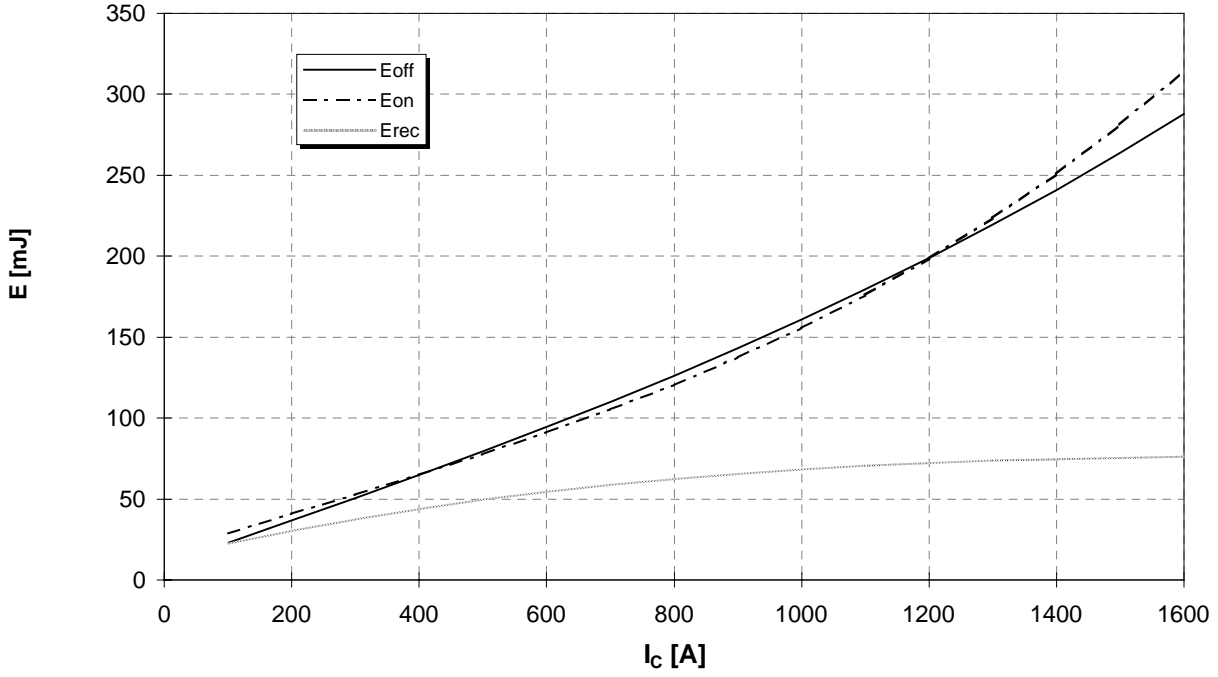
$I_F = f(V_F)$



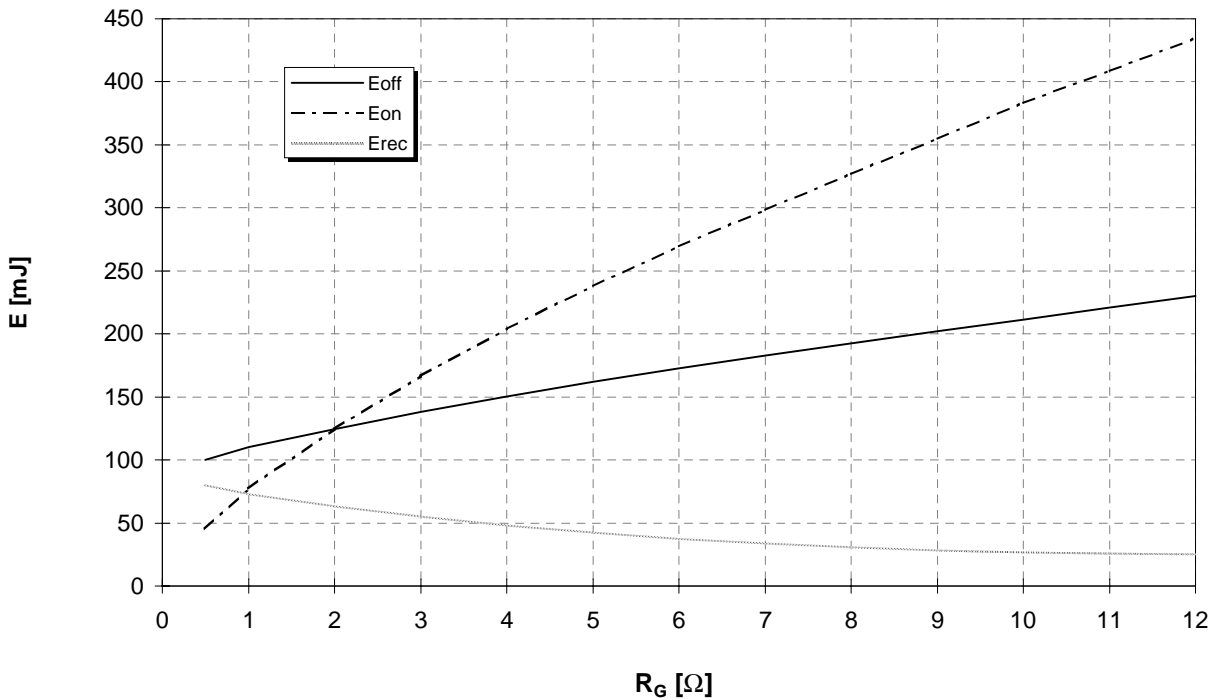


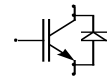
vorläufige Daten  
preliminary data

Schaltverluste (typisch)  $E_{on} = f(I_C)$ ,  $E_{off} = f(I_C)$ ,  $E_{rec} = f(I_C)$   
Switching losses (typical)  $R_{gon} = R_{goff} = 1,8 \Omega$ ,  $V_{CE} = 600V$ ,  $T_j = 125^\circ C$



Schaltverluste (typisch)  $E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$ ,  $E_{rec} = f(R_G)$   
Switching losses (typical)  $I_C = 800A$ ,  $V_{CE} = 600V$ ,  $T_j = 125^\circ C$

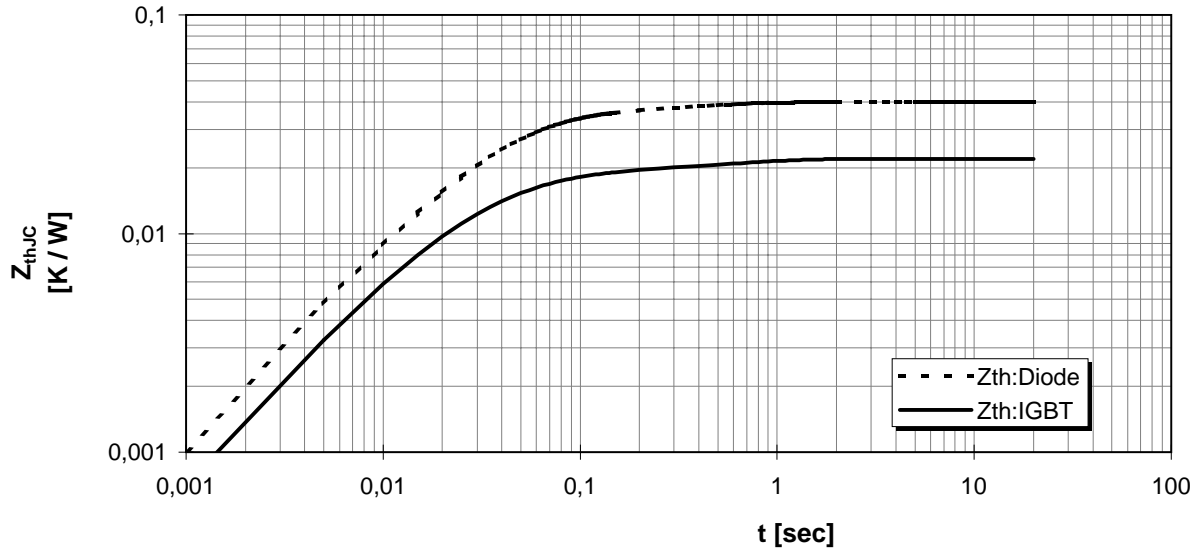




vorläufige Daten  
preliminary data

Transienter Wärmewiderstand  
Transient thermal impedance

$$Z_{thJC} = f(t)$$

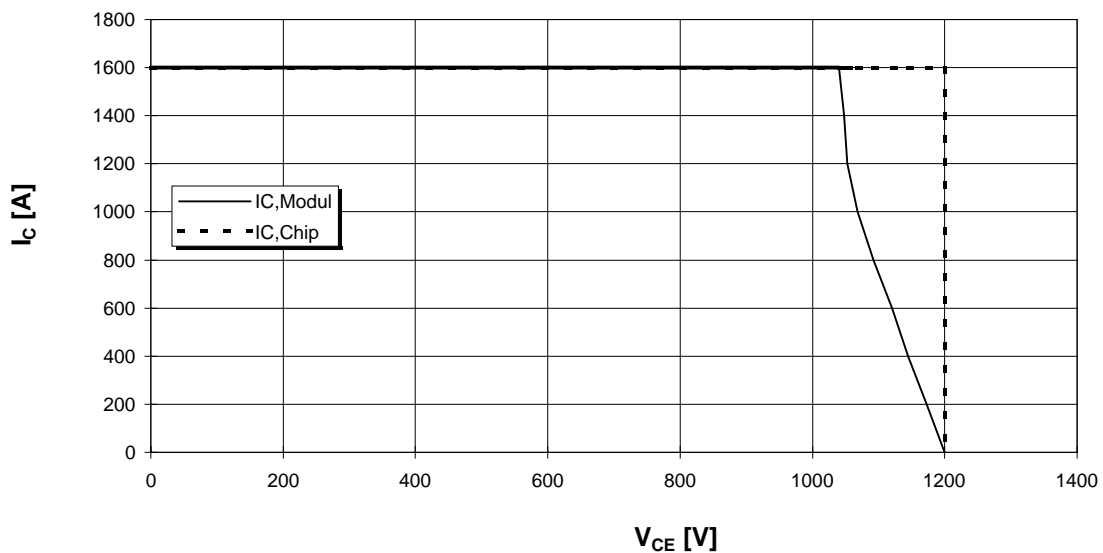


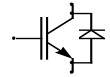
i	1	2	3	4
$r_i$ [K/kW] : IGBT	9,08	4,9	4,56	3,45
$\tau_i$ [sec] : IGBT	0,018	0,036	0,051	0,522
$r_i$ [K/kW] : Diode	18,39	6,09	9,78	5,71
$\tau_i$ [sec] : Diode	0,029	0,04	0,045	0,331

Sicherer Arbeitsbereich (RBSOA)

Reverse bias safe operation area (RBSOA)

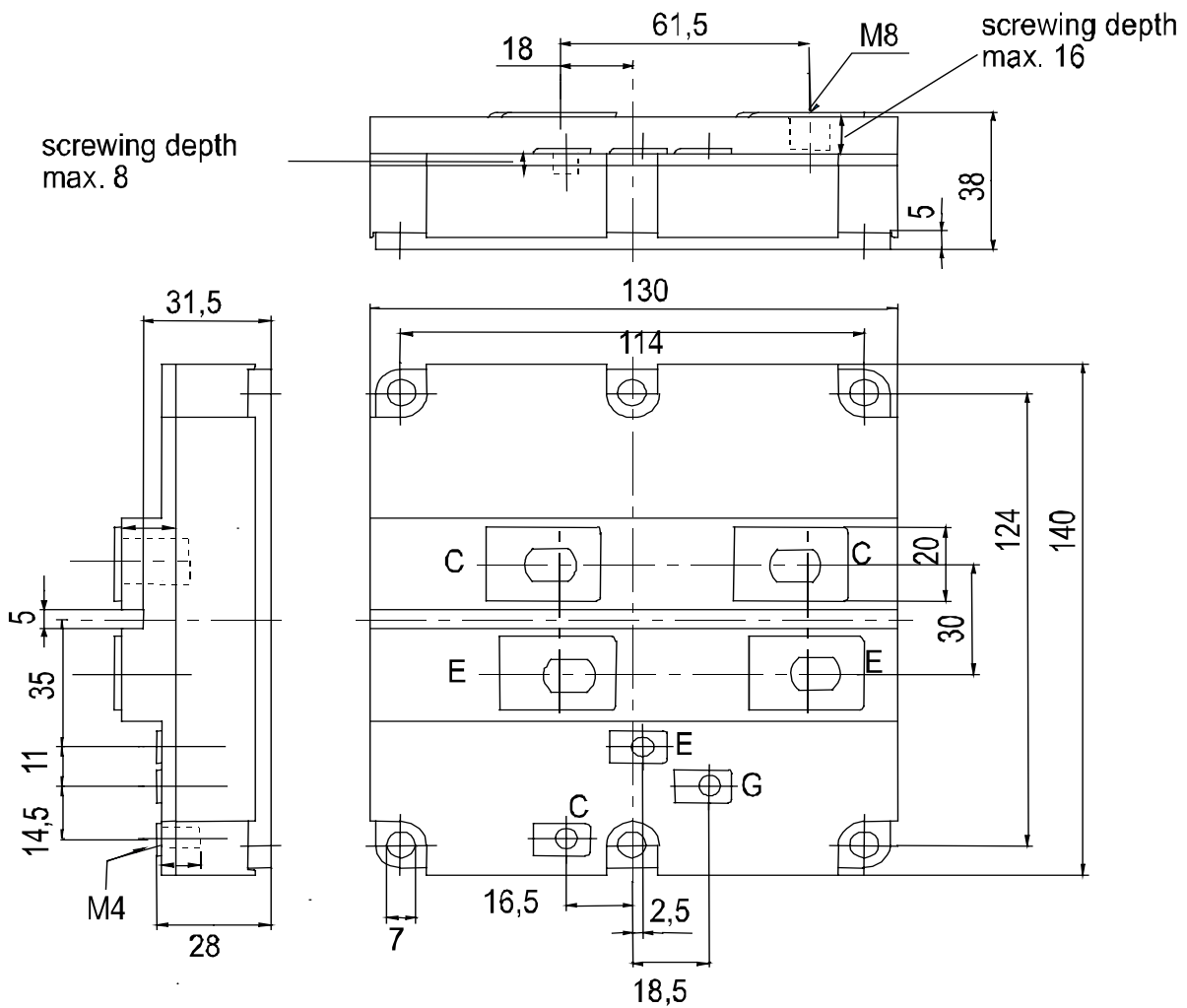
$R_g = 1,80\Omega$ ,  $T_v = 125^\circ\text{C}$



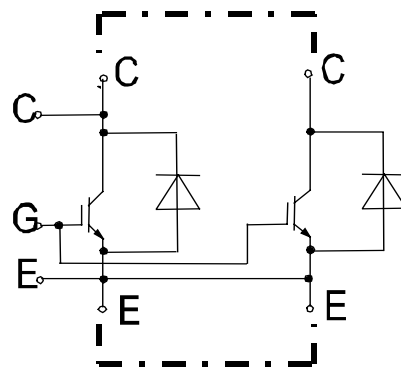


preliminary data

vorläufige Daten



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external connections ( to be done)





## **Terms & Conditions of Usage**

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